

**NANYANG TECHNOLOGICAL UNIVERSITY
SCHOOL OF ELECTRICAL & ELECTRONIC ENGINEERING
ACADEMIC YEAR 2022-2023
SEMESTER 1**

EE3013 SEMINCONDUCTOR DEVICES AND PROCESSING

Recap of PN Junctions

1. An abrupt junction silicon p-n diode has a p-layer acceptor doping density of 10^{18} cm^{-3} and n-side donor doping density of 10^{15} cm^{-3} . Assume that the dopants are fully ionized. For this junction in equilibrium at 300 K:
 - (a) Compute the position of the Fermi level (with respect to the conduction band edge) on both sides of the junction.
 - (b) Sketch the band diagram (with the energy axis drawn to scale) and estimate the built-in potential.
 - (c) Compute V_{bi} directly from the doping densities and the intrinsic concentration, and compare the result with that from part b).
 - (d) Calculate the widths of the depletion regions on either side of the junction.
 - (e) Calculate the maximum electric field in the depletion region.

Solution:

(a) For n- and p-type Si:

$$n = N_C \exp\left(\frac{E_F - E_C}{kT}\right) = N_D$$
$$p = N_V \exp\left(\frac{E_V - E_F}{kT}\right) = N_A$$

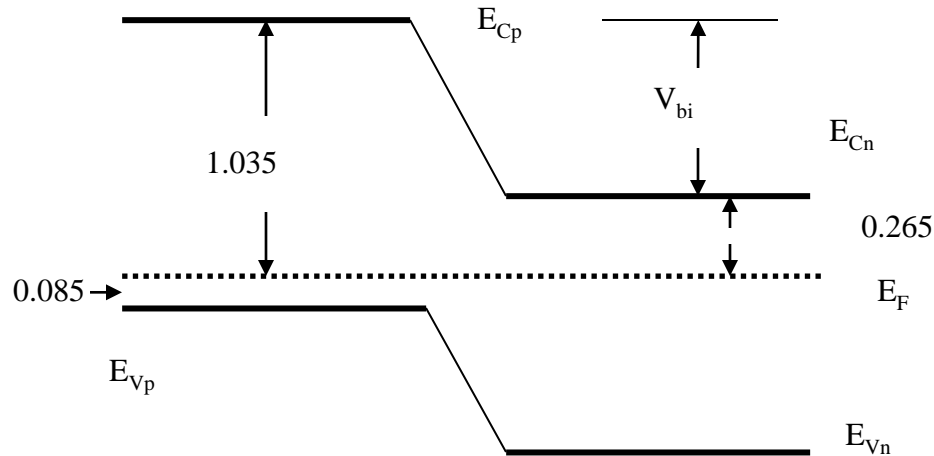
we obtain

$$E_F - E_C|_n = 0.0259 \ln\left(\frac{10^{15}}{2.8 \times 10^{19}}\right) = -0.265 \text{ eV}$$

$$E_V - E_F|_p = 0.0259 \ln\left(\frac{10^{18}}{2.66 \times 10^{19}}\right) = -0.085 \text{ eV}$$

$$E_C - E_F|_p = 1.12 - 0.085 = 1.035 \text{ eV}$$

(b) Draw E_F horizontally through the device, then add E_{vp} and E_{cn} ; finally draw E_{cp} and E_{vn} using $E_g = 1.12$ eV.



$$(c) \quad V_{bi} = \frac{kT}{q} \ln \frac{N_A N_D}{n_i^2} = 0.0259 \ln \frac{10^{33}}{(9.65 \times 10^9)^2} = 0.776 \text{ eV}$$

From the diagram above: $V_{bi} = 1.035 - 0.265 = 0.77$ eV

$$(d) \quad W = \sqrt{\frac{2\varepsilon_s}{q} (V_{bi} - V) \left(\frac{N_A + N_D}{N_D N_A} \right)} \quad x_p = 9.99 \times 10^{-4} \mu m = 9.99 \times 10^{-4} \mu m$$

$$x_n = 0.999 \mu m$$

$$V = 0, \varepsilon_s = 11.9 \times 8.85 \times 10^{-14} \text{ F cm}^{-1}, W = 1 \mu m$$

$$x_n = \frac{N_A W}{N_A + N_D}, x_p = \frac{N_D W}{N_A + N_D}$$

$$\rightarrow X_p = 9.99 \times 10^{-4} \mu m$$

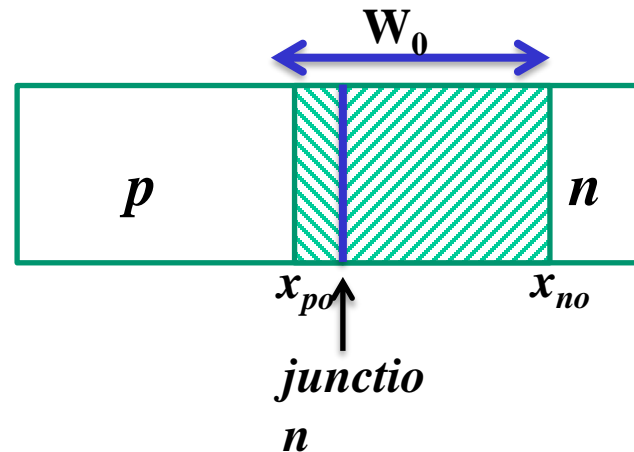
$$\rightarrow X_n = 0.999 \mu m$$

$$(e) \quad \xi_{\max} = \xi_{x=0} = -\frac{q N_A x_p}{\varepsilon_s} = -1.52 \times 10^4 \text{ V cm}^{-1}$$

2. Consider a uniformly doped abrupt pn junction at 300 K. At thermal equilibrium, it is designed such that 10 % of the total depletion width region lies in the p region. You are given that the built in potential is 0.8 V. Determine the doping concentration N_a and N_d of the p and n region, respectively, and the total depletion width.

(Hint: Consider charge neutrality and $x_{n0} + x_{p0} = W$ to relate N_a and N_d . You can relate N_a and N_d via the expression for V_{bi} . Then, solve the two equations.)

$$[2.59 \times 10^{16} \text{ cm}^{-3}; 2.33 \times 10^{17} \text{ cm}^{-3}; 0.212 \text{ } \mu\text{m}]$$



Solution 2 The desired built-in voltage is 0.8 V. Thus,

$$V_{bi} = \frac{k_B T}{q} \ln \left(\frac{N_a N_d}{n_i^2} \right) = 0.8 \text{ V} \tag{1}$$

The second requirement is that 10 % of the total depletion width is to be in the p region, i.e.

$$\frac{x_{p0}}{x_{p0} + x_{n0}} = 0.1 \Rightarrow x_{n0} = 9x_{p0} \tag{2}$$

In addition,

$$x_{p0} N_a = x_{n0} N_d \Rightarrow N_a = 9N_d \tag{3}$$

$$\begin{aligned} N_d &= \frac{n_i}{3} \exp \left(\frac{q}{2k_B T} V_{bi} \right) \\ &= \frac{1.5 \times 10^{10}}{3} \exp \left(\frac{1.6 \times 10^{-19} \times 0.8}{2 \times 1.38 \times 10^{-23} \times 300} \right) \\ &= 2.59 \times 10^{16} \text{ cm}^{-3} \end{aligned}$$

$$N_a = 9N_d = 2.33 \times 10^{17} \text{ cm}^{-3}$$

$$\begin{aligned} V_o &= \frac{kT}{q} \ln \left(\frac{N_a N_d}{n_i^2} \right) \\ \Rightarrow qV_o / kT &= \ln \left(\frac{9N_d^2}{n_i^2} \right) = 2 \ln \left(\frac{3N_d}{n_i} \right) \\ \Rightarrow \left(\frac{3N_d}{n_i} \right) &= \exp(qV_o / 2kT) \\ \Rightarrow N_d &= \frac{n_i}{3} \exp(qV_o / 2kT) \end{aligned}$$

Solution 2 (continued)

Total depletion width,

$$\begin{aligned} W &= \left[\frac{2\varepsilon_r\varepsilon_0}{q} V_{bi} \left(\frac{1}{N_a} + \frac{1}{N_d} \right) \right]^{1/2} \\ &= \left[\frac{2 \times 11.8 \times 8.85 \times 10^{-14} \times 0.8}{1.6 \times 10^{-19}} \times \left(\frac{1}{2.33 \times 10^{17}} + \frac{1}{2.59 \times 10^{16}} \right) \right]^{1/2} \\ &= 2.12 \times 10^{-5} \text{ cm} \quad \text{or } 0.212 \text{ } \mu\text{m} \end{aligned}$$

3. Assume that the p-n abrupt junction has $N_A = 10^{17} \text{ cm}^{-3}$ and $N_D = 10^{15} \text{ cm}^{-3}$,
- a) Calculate V_{bi} at 250 and 500 K and list V_{bi} versus T .
 - b) Comment on your result in terms of energy band diagram.
 - c) Find the depletion layer width and maximum field at zero bias for $T = 500 \text{ K}$.

Assume that the intrinsic carrier concentrations at 250 and 500 K are $1.5 \times 10^8 \text{ cm}^{-3}$ and $2.2 \times 10^{14} \text{ cm}^{-3}$ respectively.

(a) From the figure, the intrinsic carrier concentrations at different temperatures can be obtained, one can thus get built-in potential.

$$V_{bi} = \frac{kT}{q} \ln \left(\frac{N_A N_D}{n_i^2} \right) = \frac{1.38 \times 10^{-23} T}{1.6 \times 10^{-19}} \ln \left(\frac{10^{17} \times 10^{15}}{n_i^2} \right)$$

$$= 8.63 \times 10^{-5} \times T \times \ln \left(\frac{10^{32}}{n_i^2} \right)$$

The V_{bi} results are listed in the following table.

T	n_i	V_{bi} (V)
250	1.500E+08	0.777
500	2.20E+14	0.329

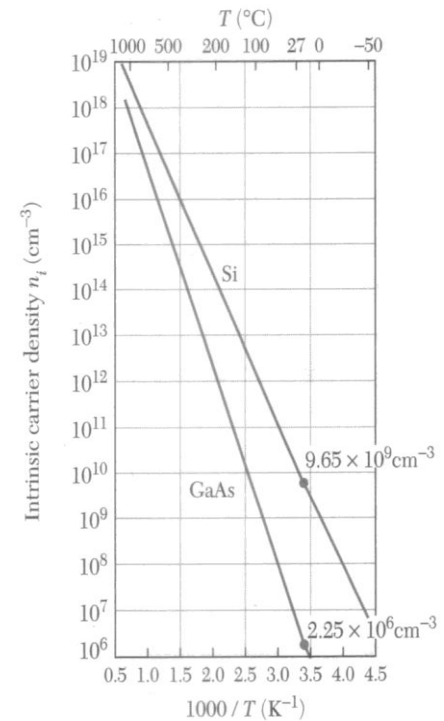
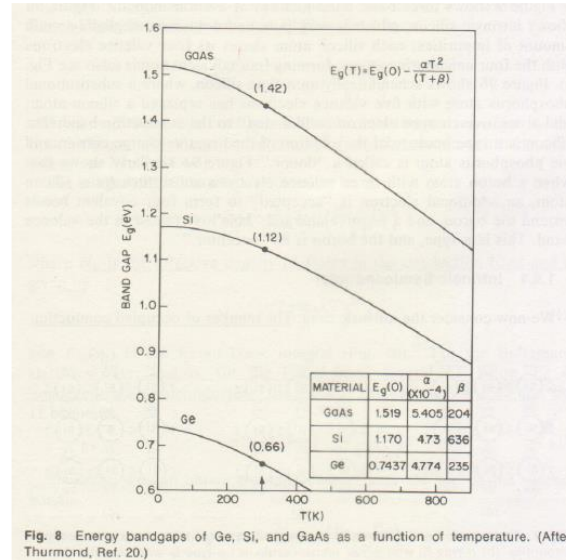


Fig. 22 Intrinsic carrier densities in Si and GaAs as a function of the reciprocal of temperature.⁵⁻⁷

(b) $E_g(300\text{K}) = 1.12\text{eV}$; $E_g(500\text{K}) = 1.05\text{eV} \Rightarrow n_i$ and p_i increase

Thus, V_{bi} is decreased as the temperature is increased.



(C) Depletion width W and maximum field at zero bias at $T=500\text{ K}$

$$W = \sqrt{\frac{2\epsilon_s V_{bi}}{qN_D}} = 0.658 \mu\text{m}$$

$$\xi_{\text{max}} = \frac{qN_D W}{\epsilon_s} = 1 \times 10^4 \text{ V/cm}$$

4. A one-sided p-n junction at 300 K is doped with $N_A = 10^{19} \text{ cm}^{-3}$. Design the junction so that $C_j = 0.85 \times 10^{-8} \text{ F/cm}^2$ at a reverse voltage of 4 V.

We know

$$\frac{1}{C_j^2} = \frac{2(V_{bi} - V)}{q\epsilon_s N_B} \Rightarrow N_D = \frac{2(V_{bi} - V_R)}{q\epsilon_s} C_j^2$$

$$\because V_R \gg V_{bi} \Rightarrow N_D \cong \frac{2(V_R)}{q\epsilon_s} C_j^2$$

$$= \frac{2 \times 4}{1.6 \times 10^{-19} \times 11.9 \times 8.85 \times 10^{-14}} \times (0.85 \times 10^{-8})^2$$
$$\Rightarrow N_d = 3.43 \times 10^{15} \text{ cm}^{-3}$$

We can select the n-type doping concentration of $3.43 \times 10^{15} \text{ cm}^{-3}$.

If you do not neglect V_{bi} , and use the equation $V_{bi} = \frac{kT}{q} \ln \frac{N_A N_D}{n_i^2}$

Then the above equation for $1/C_j^2$ becomes

$$N_D = \frac{2C_j^2}{q\epsilon_s} \left[\frac{kT}{q} \left\{ \ln \frac{N_A}{n_i^2} + \ln N_D \right\} - V_R \right]$$

$$N_D = 3.38 \times 10^{15} + 2.22 \times 10^{13} \ln(N_D)$$

Solve using iteration. The solution converges. Two iterations are sufficient.
Take an initial value of

$$N_D = 1 \times 10^{15} \text{ cm}^{-3} (\ll N_A)$$

$$\text{Final result: } N_D = 4.18 \times 10^{15} \text{ cm}^{-3}$$

5. Design the Si p-n diode such that $J_n = 25 \text{ A.cm}^{-2}$ and $J_p = 7 \text{ A.cm}^{-2}$ at $V_a = 0.7 \text{ V}$. Other parameters include $n_i = 9.65 \times 10^9 \text{ cm}^{-3}$, $D_n = 21 \text{ cm}^2/\text{s}$, $D_p = 10 \text{ cm}^2/\text{s}$ and $\tau_n = \tau_p = 5 \times 10^{-7} \text{ s}$. Assume that J_p and J_n are given by expressions of the form $(qD_p p_{no}/L_p) \cdot (e^{qV/kT} - 1)$ and $(qD_n n_{po}/L_n) \cdot (e^{qV/kT} - 1)$ respectively.

$$J_p(x_n) = \frac{qD_p p_{no}}{L_p} (e^{qV/kT} - 1) = q \sqrt{\frac{D_p}{\tau_{po}}} \times \frac{n_i^2}{N_D} \times \left[e^{\left(\frac{qV_a}{kT}\right)} - 1 \right]$$

$$7 = 1.6 \times 10^{-19} \times \sqrt{\frac{10}{5 \times 10^{-7}}} \times \frac{(9.65 \times 10^9)^2}{N_D} \times \left[e^{\left(\frac{0.7}{0.0259}\right)} - 1 \right]$$

$$\therefore N_D = 5.2 \times 10^{15} \text{ cm}^{-3}$$

$$J_n(-x_p) = \frac{qD_n n_{po}}{L_n} (e^{qV/kT} - 1) = q \sqrt{\frac{D_n}{\tau_{no}}} \times \frac{n_i^2}{N_A} \times \left[e^{\left(\frac{qV_a}{kT}\right)} - 1 \right]$$

$$25 = 1.6 \times 10^{-19} \times \sqrt{\frac{21}{5 \times 10^{-7}}} \times \frac{(9.65 \times 10^9)^2}{N_A} \times \left[e^{\left(\frac{0.7}{0.0259}\right)} - 1 \right]$$

$$\therefore N_A = 2.1 \times 10^{15} \text{ cm}^{-3}$$